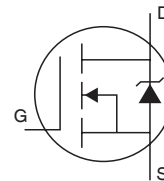## Applications

- DC Motor Drive
- High Efficiency Synchronous Rectification in SMPS
- Uninterruptible Power Supply
- High Speed Power Switching
- Hard Switched and High Frequency Circuits

Benefits

- Optimized for Logic Level Drive
- Very Low $R_{DS(ON)}$ at 4.5V V_{GS}
- Superior R*Q at 4.5V V_{GS}
- Improved Gate, Avalanche and Dynamic dV/dt Ruggedness
- Fully Characterized Capacitance and Avalanche SOA
- Enhanced body diode dV/dt and dI/dt Capability
- Lead-Free

- $V_{DS}(V) = 40V$
- $I_D = 195A$ ($V_{GS} = 10V$)
- $R_{DS(ON)} < 1.7m\Omega$ ($V_{GS} = 10V$)
- $R_{DS(ON)} < 2.0m\Omega$ ($V_{GS} = 4.5V$)

Absolute Maximum Ratings

Symbol	Parameter	Max.	Units
I_D @ T_C = 25°C	Continuous Drain Current, V_{GS} @ 10V (Silicon Limited)	343①	A
I_D @ T_C = 100°C	Continuous Drain Current, V_{GS} @ 10V (Silicon Limited)	243 ①	
I_D @ T_C = 25°C	Continuous Drain Current, V_{GS} @ 10V (Package Limited)	195	
I_{DM}	Pulsed Drain Current ②	1372	
P_D @T_C = 25°C	Maximum Power Dissipation	375	W
	Linear Derating Factor	2.5	W/°C
V_{GS}	Gate-to-Source Voltage	±20	V
dv/dt	Peak Diode Recovery ④	4.6	V/ns
T_J T_{STG}	Operating Junction and Storage Temperature Range	-55 to + 175	°C
	Soldering Temperature, for 10 seconds (1.6mm from case)	300	
	Mounting torque, 6-32 or M3 screw	10lbf·in (1.1N·m)	
$E_{AS\ (Thermally\ limited)}$	Single Pulse Avalanche Energy ③	255	mJ
I_{AR}	Avalanche Current ②	See Fig. 14, 15, 22a, 22b,	A
E_{AR}	Repetitive Avalanche Energy ②		mJ

Thermal Resistance

Symbol	Parameter	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case ⑧		0.4	°C/W
$R_{\theta CS}$	Case-to-Sink, Flat, Greased Surface	0.5		
$R_{\theta JA}$	Junction-to-Ambient		62	

Static @ T_J = 25°C (unless otherwise specified)

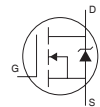| Symbol	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(BR)DSS}$	Drain-to-Source Breakdown Voltage	40			V	V_{GS} = 0V, I_D = 250µA
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient		0.04		V/°C	Reference to 25°C, I_D = 5mA②
$R_{DS(on)}$	Static Drain-to-Source On-Resistance		1.4	1.7	mΩ	V_{GS} = 10V, I_D = 195A ⑤
		1.6		2.0		V_{GS} = 4.5V, I_D = 172A ⑤
$V_{GS(th)}$	Gate Threshold Voltage	1.0		2.5	V	V_{DS} = V_{GS}, I_D = 250µA
I_{DSS}	Drain-to-Source Leakage Current			20	µA	V_{DS} = 40V, V_{GS} = 0V
				250		V_{DS} = 40V, V_{GS} = 0V, T_J = 125°C
I_{GSS}	Gate-to-Source Forward Leakage			100	nA	V_{GS} = 20V
	Gate-to-Source Reverse Leakage			-100		V_{GS} = -20V
$R_{G(int)}$	Internal Gate Resistance		2.1		Ω	
gfs	Forward Transconductance	286			S	V_{DS} = 10V, I_D = 195A
Q_g	Total Gate Charge		108	162	nC	I_D = 185A
Q_{gs}	Gate-to-Source Charge		29			V_{DS} = 20V
Q_{gd}	Gate-to-Drain ("Miller") Charge		54			V_{GS} = 4.5V ⑤
Q_{sync}	Total Gate Charge Sync. (Q_g - Q_{gd})		54			I_D = 185A, V_{DS} =0V, V_{GS} = 4.5V
$t_{d(on)}$	Turn-On Delay Time		65		ns	V_{DD} = 26V
t_r	Rise Time		827			I_D = 195A
$t_{d(off)}$	Turn-Off Delay Time		97			R_G = 2.1Ω
t_f	Fall Time		355			V_{GS} = 4.5V ⑤
C_{iss}	Input Capacitance		10315		pF	V_{GS} = 0V
C_{oss}	Output Capacitance		1980			V_{DS} = 25V
C_{rss}	Reverse Transfer Capacitance		935			f = 1.0MHz
C_{oss} eff. (ER)	Effective Output Capacitance (Energy Related)⑦		2378			V_{GS} = 0V, V_{DS} = 0V to 32V ⑦
C_{oss} eff. (TR)	Effective Output Capacitance (Time Related) ⑥		2986			V_{GS} = 0V, V_{DS} = 0V to 32V ⑥
I_S	Continuous Source Current (Body Diode)			343①	A	MOSFET symbol showing the integral reverse p-n junction diode.
I_{SM}	Pulsed Source Current (Body Diode) ②			1372		
V_{SD}	Diode Forward Voltage			1.3	V	T_J = 25°C, I_S = 195A, V_{GS} = 0V ⑤
t_{rr}	Reverse Recovery Time		39		ns	T_J = 25°C V_R = 34V,
			41			T_J = 125°C I_F = 195A
Q_{rr}	Reverse Recovery Charge		39		nC	T_J = 25°C di/dt = 100A/µs ⑤
			46			T_J = 125°C
I_{RRM}	Reverse Recovery Current		1.7		A	T_J = 25°C
t_{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

Notes:

① Calcuted continuous current based on maximum allowable junction temperature Bond wire current limit is 195A. Note that current limitation arising from heating of the device leds may occur with some lead mounting arrangements.

② Repetitive rating; pulse width limited by max. junction temperature.

③ Limited by T_{Jmax}, starting T_J = 25°C, L = 0.013mH
R_G = 25Ω, I_{AS} = 195A, V_{GS} =10V. Part not recommended for use above this value .

④ $I_{SD} \le$ 195A, di/dt $\le$ 841A/µs, $V_{DD} \le V_{(BR)DSS}$, $T_J \le$ 175°C.

⑤ Pulse width $\le$ 400µs; duty cycle $\le$ 2%.

⑥ C_{oss} eff. (TR) is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS}.

⑦ C_{oss} eff. (ER) is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS}.

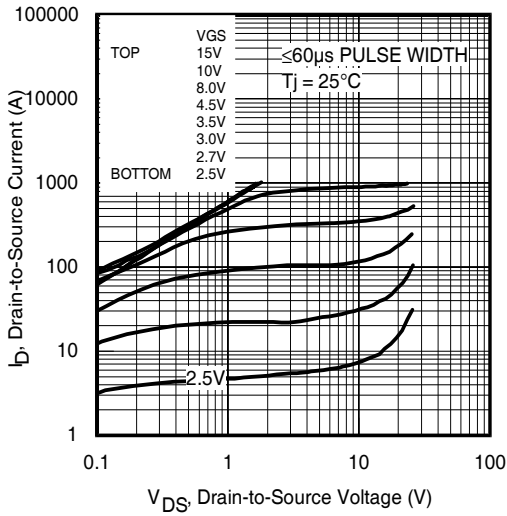⑧ R_θ is measured at T_J approximately 90°C

Fig 1. Typical Output Characteristics
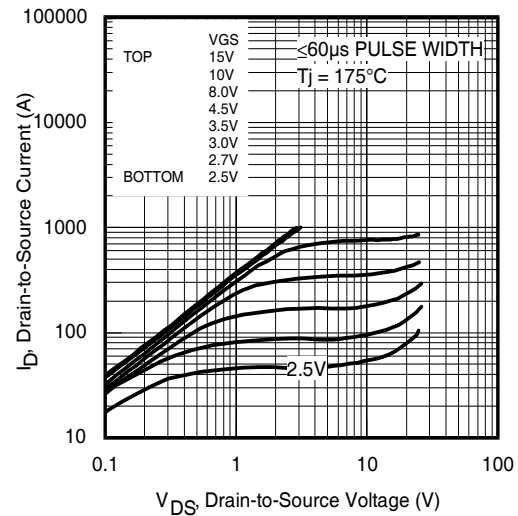

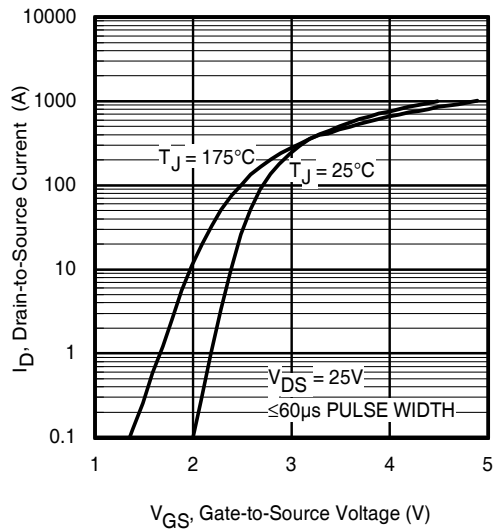**Fig 2.** Typical Output Characteristics

Fig 3. Typical Transfer Characteristics
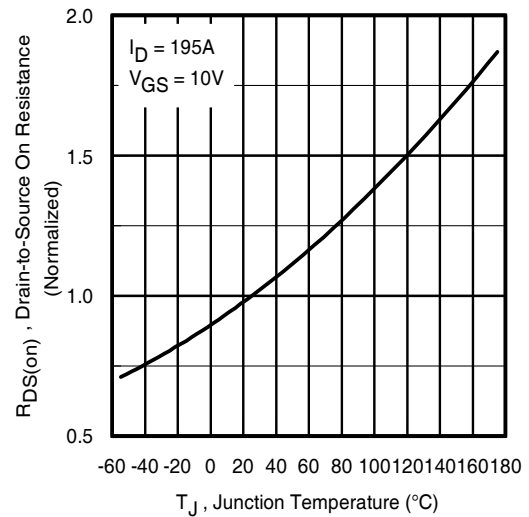

Fig 4. Normalized On-Resistance vs. Temperature
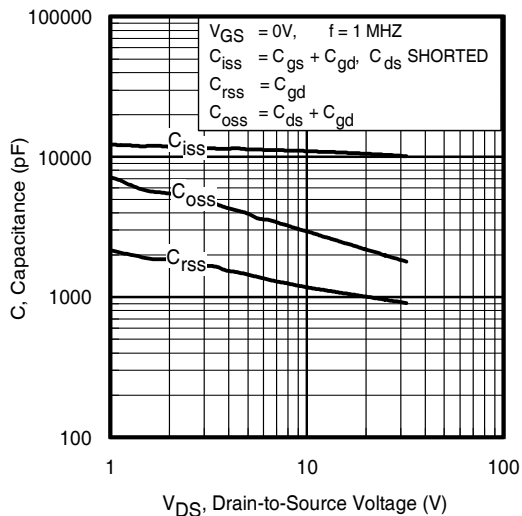

Fig 5. Typical Capacitance vs. Drain-to-Source Voltage
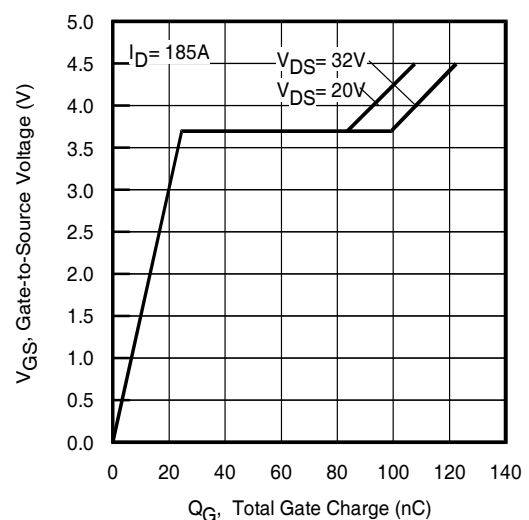

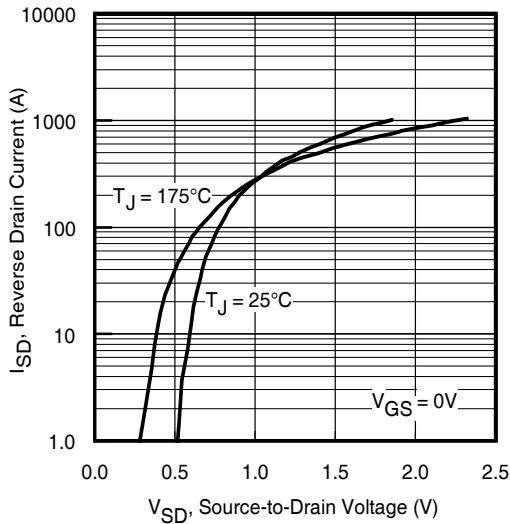**Fig 6.** Typical Gate Charge vs. Gate-to-Source Voltage

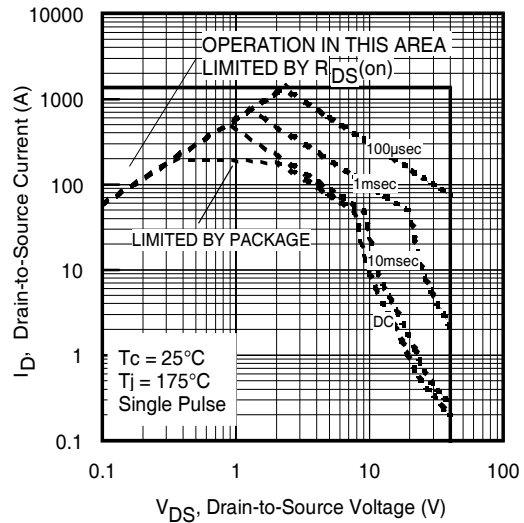**Fig 7.** Typical Source-Drain Diode Forward Voltage
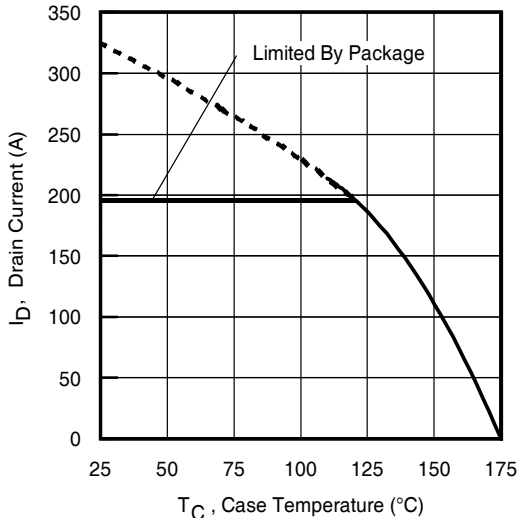

Fig 8. Maximum Safe Operating Area

Fig 9. Maximum Drain Current vs. Case Temperature
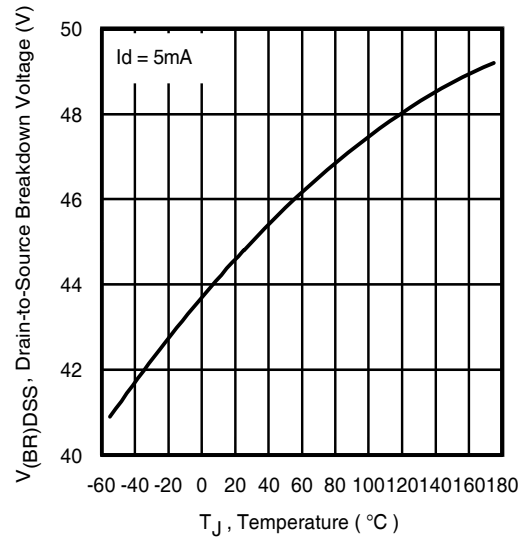

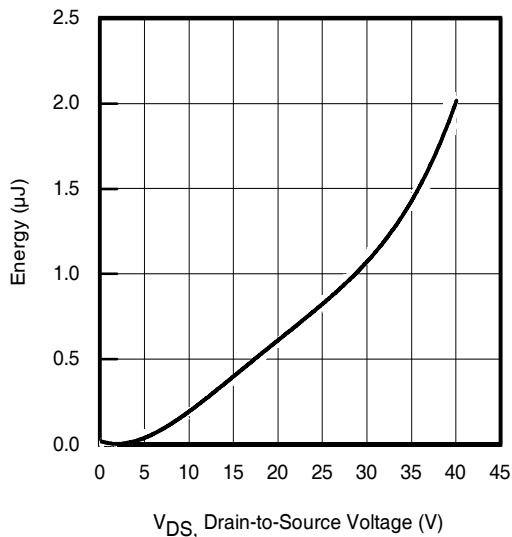**Fig 10.** Drain-to-Source Breakdown Voltage
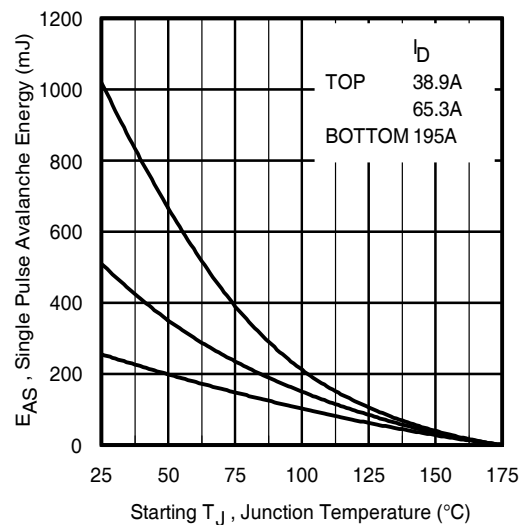

Fig 11. Typical C_{OSS} Stored Energy

Fig 12. Maximum Avalanche Energy vs. DrainCurrent
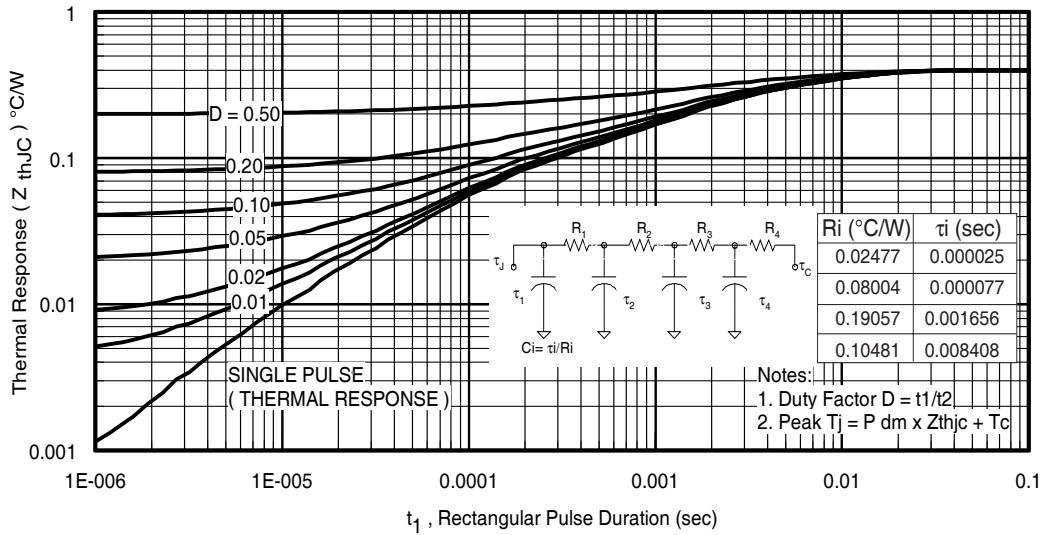
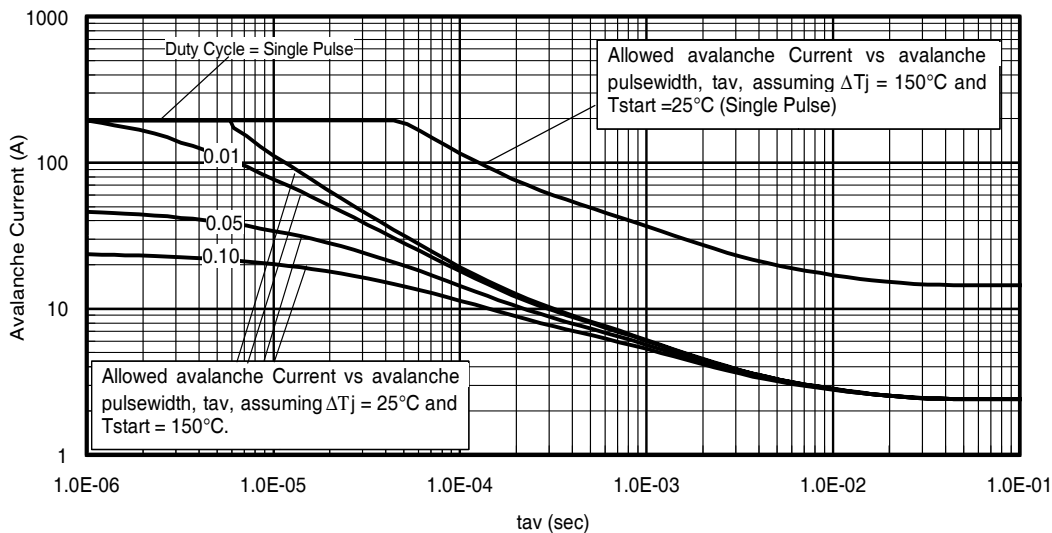**Fig 13.** Maximum Effective Transient Thermal Impedance, Junction-to-Case

The chart includes a table:

Ri (°C/W)	τi (sec)
0.02477	0.000025
0.08004	0.000077
0.19057	0.001656
0.10481	0.008408

Ci= τi/Ri

Notes:
1. Duty Factor D = t1/t2
2. Peak Tj = P dm x Zthjc + Tc

t_1 , Rectangular Pulse Duration (sec)

Thermal Response (Z_{thJC}) °C/W

SINGLE PULSE (THERMAL RESPONSE)

D = 0.50, 0.20, 0.10, 0.05, 0.02, 0.01

Fig 14. Typical Avalanche Current vs. Pulsewidth

Duty Cycle = Single Pulse

Allowed avalanche Current vs avalanche pulsewidth, tav, assuming ΔTj = 150°C and Tstart =25°C (Single Pulse)

Allowed avalanche Current vs avalanche pulsewidth, tav, assuming ΔTj = 25°C and Tstart = 150°C.

Avalanche Current (A)

tav (sec)

0.01, 0.05, 0.10

Fig 15. Maximum Avalanche Energy vs. Temperature

TOP   Single Pulse
BOTTOM   1.0% Duty Cycle
I_D = 195A

E_{AR} , Avalanche Energy (mJ)

Starting T_J , Junction Temperature (°C)

Notes on Repetitive Avalanche Curves , Figures 14, 15:

1. Avalanche failures assumption:
   Purely a thermal phenomenon and failure occurs at a temperature far in excess of T_{jmax}. This is validated for every part type.
2. Safe operation in Avalanche is allowed as long as T_{jmax} is not exceeded.
3. Equation below based on circuit and waveforms shown in Figures 16a, 16b.
4. $P_{D\ (ave)}$ = Average power dissipation per single avalanche pulse.
5. BV = Rated breakdown voltage (1.3 factor accounts for voltage increase during avalanche).
6. I_{av} = Allowable avalanche current.
7. ΔT = Allowable rise in junction temperature, not to exceed T_{jmax} (assumed as 25°C
   t_{av} = Average time in avalanche.
   D = Duty cycle in avalanche = $t_{av} \cdot f$
   $Z_{thJC}(D, t_{av})$ = Transient thermal resistance)

$$P_{D\ (ave)} = 1/2\ (\ 1.3 \cdot BV \cdot I_{av}) = \Delta T / Z_{thJC}$$
$$I_{av} = 2\Delta T / [1.3 \cdot BV \cdot Z_{th}]$$
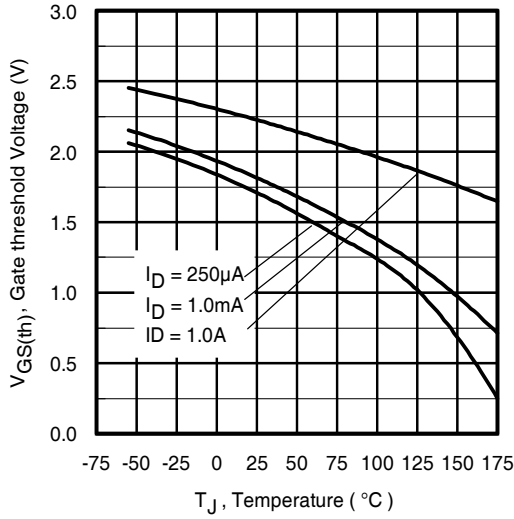$$E_{AS\ (AR)} = P_{D\ (ave)} \cdot t_{av}$$
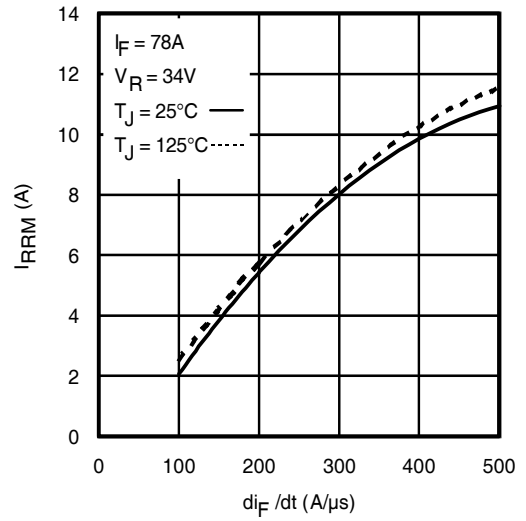
Fig 16. Threshold Voltage vs. Temperature

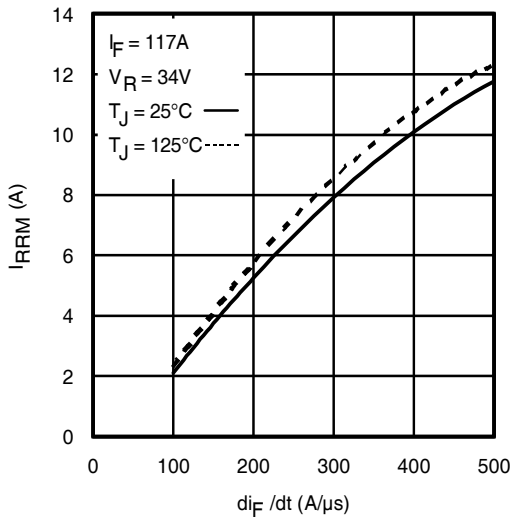**Fig 17.** Typical Recovery Current vs. di$_f$/dt
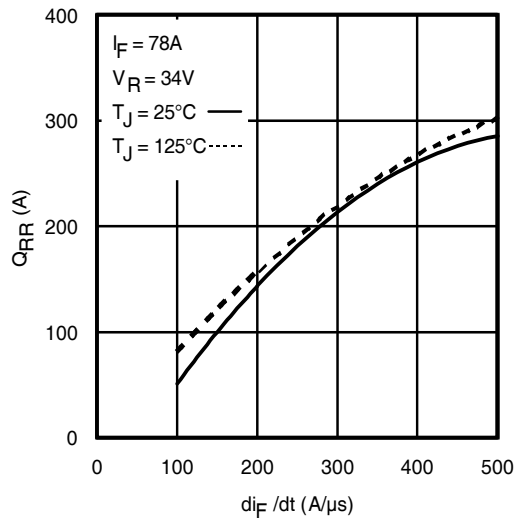

Fig 18. Typical Recovery Current vs. di$_f$/dt
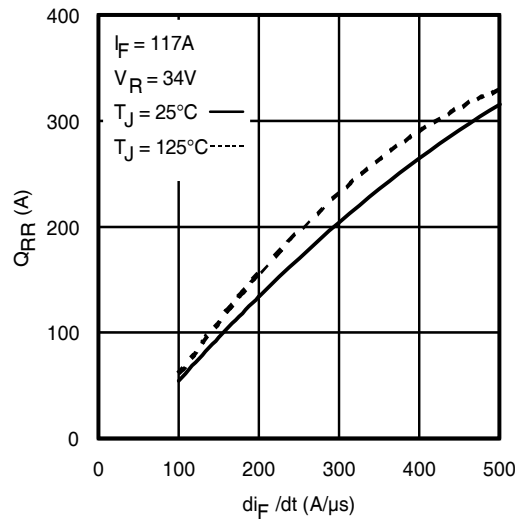

Fig 19. Typical Stored Charge vs. di$_f$/dt

Fig 20. - Typical Stored Charge vs. di$_f$/dt

Package Demensions

TO 220

Symbol	Dimensions（mm）	Symbol	Dimensions (mm)	Symbol	Dimensions (mm)
A	10.0±0.3	C1	1.3±0.2	L	13.2±0.4
A1	8.0±0.2	D	0.8±0.2	M	1.38±0.1
A2	0.94±0.1	D1	0.5±0.1	M1	1.28±0.1
A3	8.7±0.1	E	10.0±0.3	N	2.54(typ)
B	15.6±0.4	F	**2.8±0.1**	P	2.4±0.3
B1	**13.2±0.2**	H	3.6±0.1	Q	**9.15±0.25**
C	**4.5±0.2**	K	3.1±0.2		

Marking

```
┌──────────────┐
│  IRLB3034    │
│     ○        │
│  UMW XXXX    │
└──────────────┘
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Ordering information

Order code	Package	Baseqty	Deliverymode
UMW IRLB3034	TO-220	1000	Tube and box

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